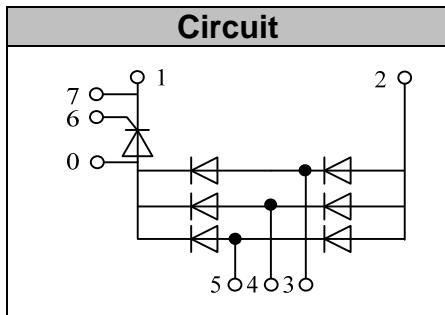




Three Phase Bridge + Thyristor

V_{RRM} / V_{DRM} 800 to 1600V
I_{FAV} / I_{TAV} 75Amp



Features

- Blocking voltage: 800 to 1600V
- Three Phase Bridge and a Thyristor
- Isolated Module package

Applications

- Inverter for AC or DC motor control
- Current stabilized power supply
- Switching power supply
- UL E243882 approved

Module Type

TYPE	V _{RRM} / V _{DRM}	V _{RSM}
MSDT75-08	800V	900V
MSDT75-12	1200V	1300V
MSDT75-16	1600V	1700V

◆ Diode

Maximum Ratings

Symbol	Item	Conditions	Values	Units
I _D	Output Current(D.C.)	T _c =101°C Three phase full wave	75	A
I _{FSM}	Surge forward current	t=10mS T _{vj} =45°C	920	A
i ² t	Circuit Fusing Consideration		4200	A ² s
V _{Isol}	Isolation Breakdown Voltage(R.M.S)	a.c.50HZ;r.m.s.;1min	3000	V
T _{vj}	Operating Junction Temperature		-40 to +150	°C
T _{stg}	Storage Temperature		-40 to +125	°C
M _t	Mounting Torque	To terminals(M5)	3±15%	Nm
M _s		To heatsink(M5)	3±15%	Nm
Weight		Module (Approximately)	210	g

Thermal Characteristics

Symbol	Item	Conditions	Values	Units
R _{th(j-c)}	Thermal Impedance, max.	Junction to Case(TOTAL)	0.20	°C/W
R _{th(c-s)}	Thermal Impedance, max.	Case to Heatsink	0.10	°C/W

Electrical Characteristics

Symbol	Item	Conditions	Values	Units
V _F M	Forward Voltage Drop, max.	T=25°C I _F =100A	1.40	V
I _{RRM}	Repetitive Peak Reverse Current, max.	T _{vj} =25°C V _{RD} =V _{RRM} T _{vj} =150°C V _{RD} =V _{RRM}	≤0.5 ≤6	mA mA

◆Thyristor
Maximum Ratings

Symbol	Item	Conditions	Values	Units
I _{TAV}	Average On-State Current	Tc=99°C, Single Phase half wave 180° conduction	75	A
I _{TSM}	Surge On-State Current	TVJ=45° t=10ms (50Hz), sine VR=0	920	A
i ² t	Circuit Fusing Consideration		4200	A ² s
Visol	Isolation Breakdown Voltage(R.M.S)	a.c.50HZ;r.m.s.;1 min	3000	V
Tvj	Operating Junction Temperature		-40 to +125	°C
Tstg	Storage Temperature		-40 to +125	°C
Mt	Mounting Torque	To terminals(M5)	3±15%	Nm
Ms		To heatsink(M5)	3±15%	Nm
di/dt	Critical Rate of Rise of On-State Current	T _{VJ} =T _{VJM} , V _D =1/2V _{DRM} , I _G =100mA d _{iG} /d _t =0.1A/μs	150	A/μs
dv/dt	Critical Rate of Rise of Off-State Voltage, min.	T _J =T _{VJM} , V _D =2/3V _{DRM} , linear voltage rise	500	V/μs

Electrical and Thermal Characteristics

Symbol	Item	Conditions	Values			Units
			Min.	Typ.	Max.	
V _{TM}	Peak On-State Voltage, max.	T=25°C I _T =100A			1.30	V
I _{RRM} /I _{DRM}	Repetitive Peak Reverse Current, max. / Repetitive Peak Off-State Current, max.	T _{VJ} =T _{VJM} , V _R =V _{RRM} , V _D =V _{DRM}			20	mA
V _{GT}	Gate Trigger Voltage, max.	T _{VJ} =25°C , V _D =6V			3	V
I _{GT}	Gate Trigger Current, max.	T _{VJ} =25°C , V _D =6V			150	mA
R _{th(j-c)}	Thermal Impedance, max.	Junction to Case			0.30	°C/W
R _{th(c-s)}	Thermal Impedance, max.	Case to Heatsink			0.10	°C/W

Performance Curves

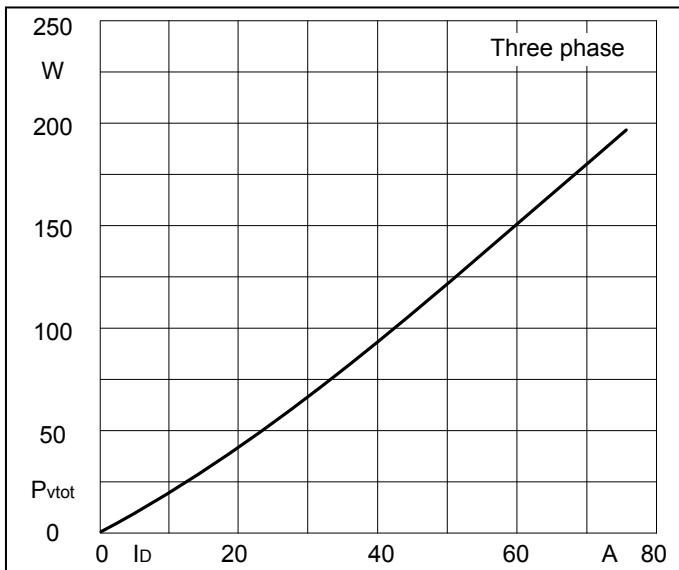


Fig1. Power dissipation

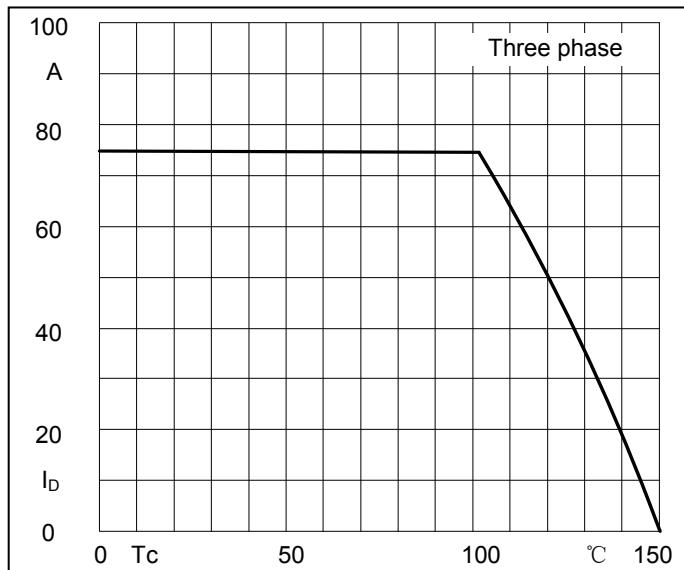


Fig2. Forward Current Derating Curve

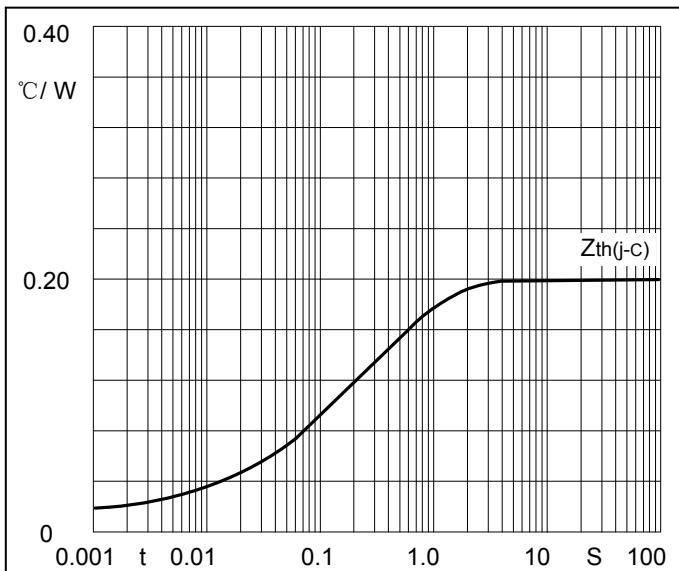


Fig3. Transient thermal impedance

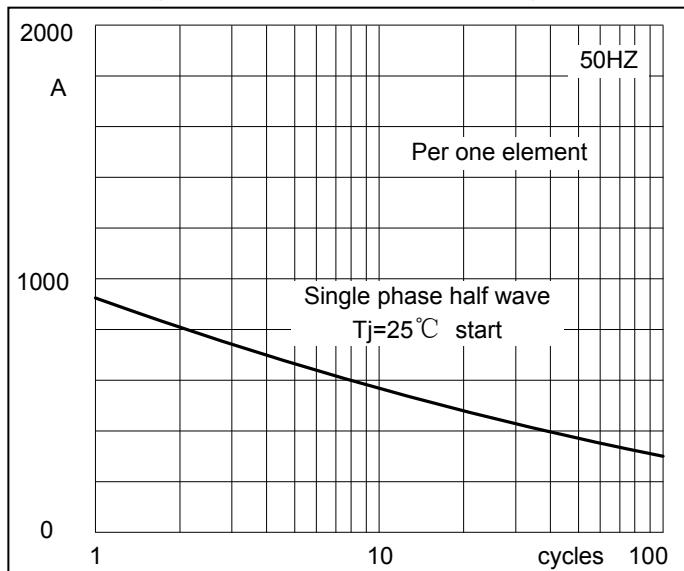


Fig4. Max Non-Repetitive Forward Surge Current

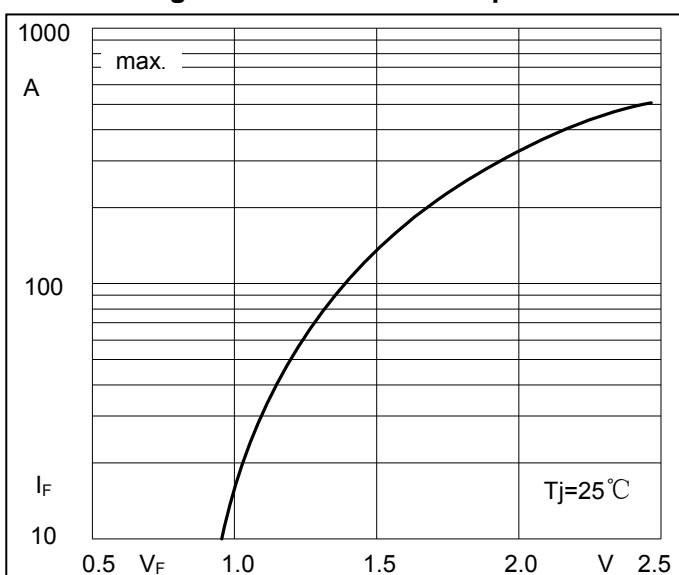


Fig5. Forward Characteristics

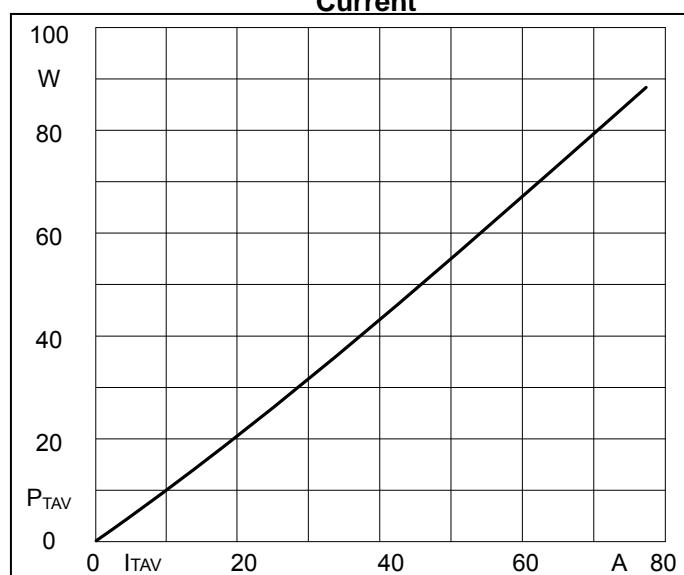


Fig6. SCR Power dissipation

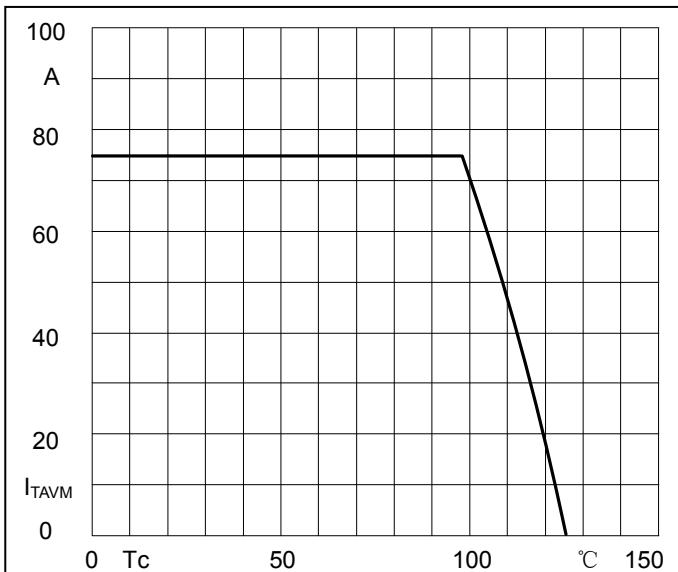


Fig7. SCR Forward Current Derating Curve

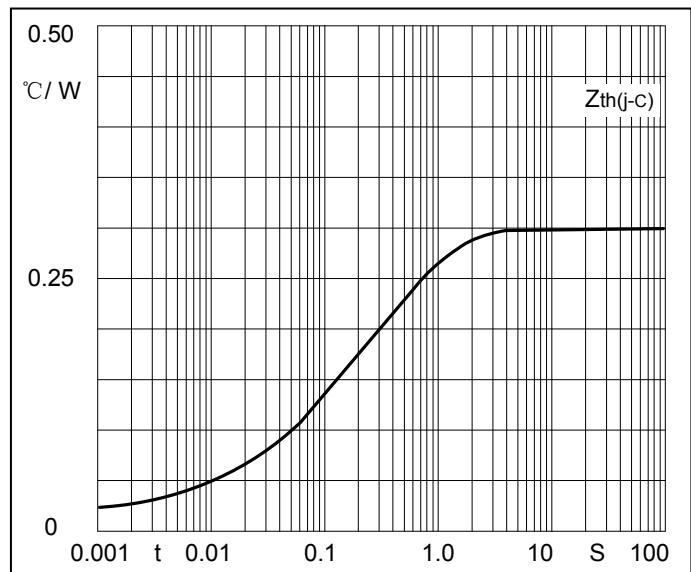


Fig8. SCR Transient thermal impedance

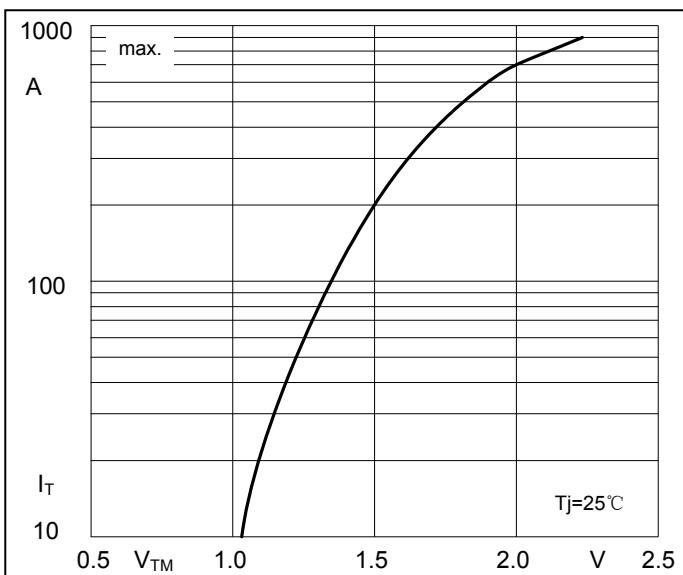


Fig9. SCR Forward Characteristics

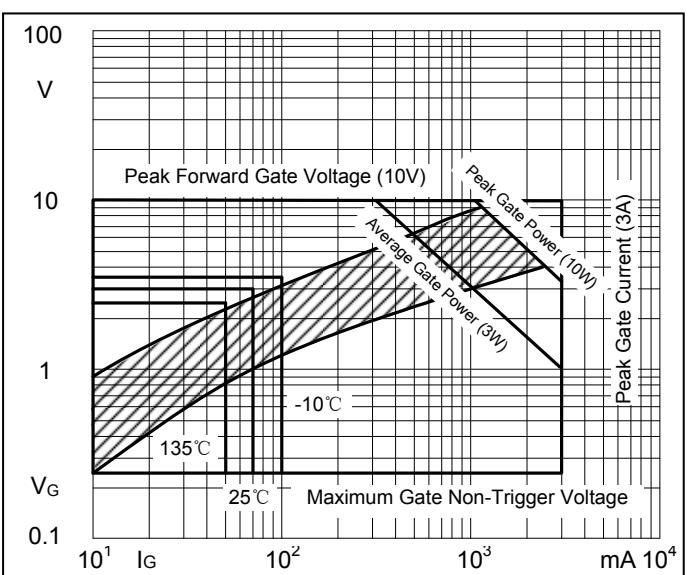


Fig10. Gate trigger Characteristics

Package Outline Information

CASE: M4

